

v04.0210



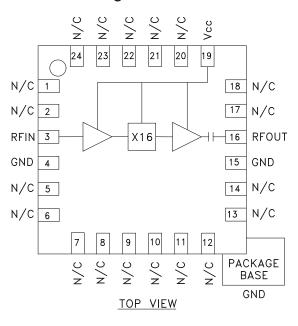
SMT GaAs HBT MMIC x16 ACTIVE FREQUENCY MULTIPLIER, 9.9 - 11.0 GHz OUTPUT

Typical Applications

Active Multiplier for X Band Applications:

- Fiber Optic
- Point-to-Point Radios
- Military Radar

Functional Diagram



Features

Output Power: +7 dBm

Sub-Harmonic Suppression: >25 dBc

SSB Phase Noise: -130 dBc/Hz

Single Supply: 5V @ 78 mA

24 Lead 4x4 mm SMT Package: 16 mm²

General Description

The HMC445LP4 & HMC445LP4E are active miniature x16 frequency multipliers utilizing InGaP GaAs HBT technology in 4x4 mm leadless surface mount packages. Power output is +7 dBm typical from a 5V supply voltage and varies little vs. input power, temperature and supply voltage. Suppression of undesired fundamental and sub-harmonics is >25 dBc typical with respect to output signal level. The low additive SSB phase noise of -130 dBc/Hz at 100 kHz offset helps the user maintain good system noise performance. The HMC445LP4 & HMC445LP4E are ideal for use in LO multiplier chains allowing reduced parts count vs. traditional approaches.

Electrical Specifications, $T_{\Delta} = +25^{\circ}$ C, Vcc=5V

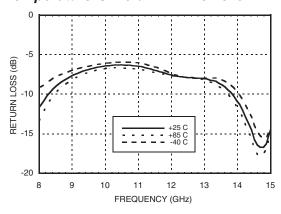
Parameter	Min.	Тур.	Max.	Units
Frequency Range, Input	618.75 - 687.50		MHz	
Frequency Range, Output	9.9 - 11.0		GHz	
Input Power Range	-15		5	dBm
Output Power	4	7		dBm
Sub-Harmonic Suppression		25		dBc
Input Return Loss		28		dB
Output Return Loss		7		dB
SSB Phase Noise (100 kHz Offset) Pin= 0 dBm		-130		dBc/Hz
Supply Current (Icc)		78	104	mA



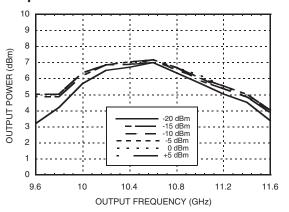


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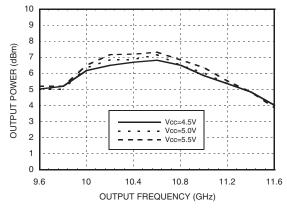
Output Power vs. Temperature @ -10 dBm Drive Level



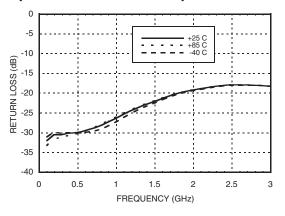
Output Power vs. Drive Level



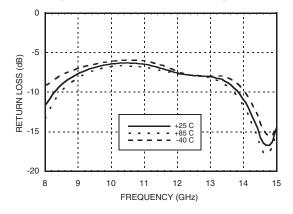
Output Power vs. Supply Voltage @ -10 dBm Drive Level



Input Return Loss vs. Temperature



Output Return Loss vs. Temperature



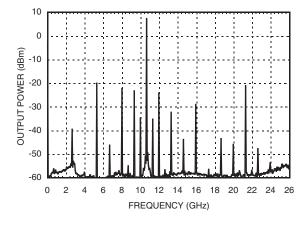


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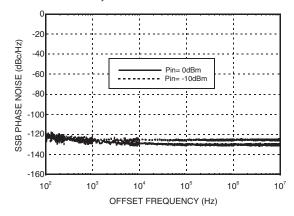


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Output Spectrum



SSB Phase Noise Performance, Fout= 10.5 GHz



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Absolute Maximum Ratings

RF Input (Vcc = +5V)	+20 dBm
Vcc	+5.5V
Channel Temperature	135 °C
Continuous Pdiss (T=85 °C) (derate 11.5 mW/°C above 85 °C)	750 mW
Thermal Resistance (R _{th}) (junction to ground paddle)	87.2 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

Typical Supply Current vs. Vcc

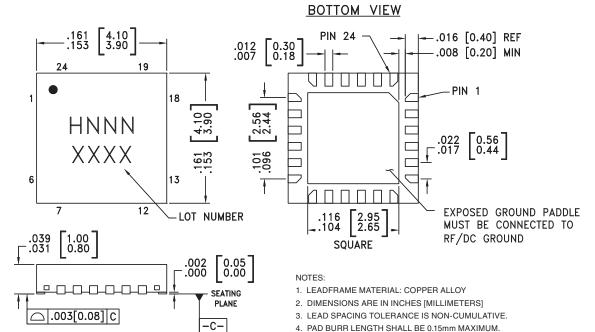
Vcc (V)	Icc (mA)	
4.5	75	
5.0	78	
5.5	80	

Note: Multiplier will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE **OBSERVE HANDLING PRECAUTIONS**

Outline Drawing



Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC445LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H445 XXXX
HMC445LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H445 XXXX

PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM. 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm. 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE

7. REFER TO HITTITE APPLICATION NOT FOR SUGGESTED

SOLDERED TO PCB RF GROUND.

LAND PATTERN.

- [1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C [3] 4-Digit lot number XXXX



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Pin Description

Pin Number	Function	Description	Interface Schematic
1, 2, 5 - 14, 17, 18, 20 - 24	N/C	The pins are not connected internally; however, all data shown herein was measured with these pins connected to RF/DC ground externally.	
3	RFIN	RF input needs to be DC blocked only if there is an external DC voltage applied to RF IN.	RFIN 0————————————————————————————————————
4, 15	GND	All ground leads and ground paddle must be soldered to PCB RF/DC ground.	GND =
16	RFOUT	Multiplied Output. AC coupled. No external DC blocks necessary.	— —○ RFOUT
19	Vcc	Supply voltage 5V ± 0.5V.	

ANALOGDEVICES

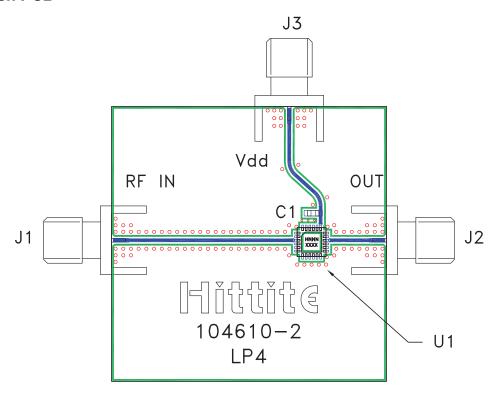
HMC445LP4 / 445LP4E

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Evaluation PCB



List of Materials for Evaluation PCB 106137 [1]

Item	Description
J1 - J3	PCB Mount SMA Connector
C1	1,000 pF Capacitor, 0603 Pkg.
U1	HMC445LP4 / HMC445LP4E x16 Active Multiplier
PCB [2]	104610 Eval Board

^[1] Reference this number when ordering complete evaluation PCB

The circuit board used in the final application should be generated with proper RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. The evaluation circuit board shown is available from Hittite upon request.

^[2] Circuit Board Material: Rogers 4350